

Electronic Patent Application Fee Transmittal

Application Number:	10785176
Filing Date:	23-Feb-2004
Title of Invention:	Method for fabricating interconnect and interconnect fabricated thereby
First Named Inventor:	Kun-Hong Chen
Filer:	Daniel R. McClure
Attorney Docket Number:	250122-1270

Filed as Large Entity

Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Independent claims in excess of 3	1201	2	200	400
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Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				1190